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AAGAARD & BALZAN, LLP

Attorney Dkt: 030204

A&B Dkt: HRL/007-03

DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare:

My residence, post office address and citizenship are as stated below beneath my name. I believe I am the original, first, and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

MICROPARTICLE LOADED SOLDER PREFORM ALLOWING BOND SITE CONTROL
OF DEVICE SPACING AT MICRON, SUBMICRON, AND NANOSTRUCTURE SCALE

the specification of which

(check one) ☒ is attached hereto

___ was filed on _____, Application Serial No. _____, as amended on _____
(if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations §1.56(a).

I do not know and do not believe that the invention was ever known or used in the United States of America before my or our invention thereof;

I do not know and do not believe that the invention was ever patented or described in any printed publication in any country before my or our invention thereof or more than one year prior to this application;

I do not know and do not believe that the invention was in public use or on sale in the United States of America more than one year prior to this application.

The invention has not been patented or made the subject of any inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by me or my legal representatives or assigns more than twelve months prior to this application; and

As to applications for patents or inventor's certificate on the invention filed in any country foreign to the United States of America, prior to this application by me or my legal representatives or assign:

☒ no such applications have been filed, or
☐ such applications have been filed as follows:

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

<u>NONE</u> (Number)	<u> </u> (Country)	<u> </u> (Day/Month/Year filed)	<u> </u> Priority Claimed
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I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112. I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations §1.56(a), which occurred between the filing date of the prior application and that national or PCT international filing date of this application.

<u>NONE</u> Application Serial No.	<u> </u> Filing Date	<u> </u> Status
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I hereby appoint the following as my attorneys with full power of substitution to prosecute this application and transact all business in the Patent Office connected therewith:

<u>Name</u>	<u>Registration No.</u>
Christopher R. Balzan	40,901
Eric J. Aagaard	40,478

Send correspondence to:

AAGAARD & BALZAN, LLP
674 County Square Drive, Suite 105
Ventura, CA 93003

I hereby declare that all statements herein of my own knowledge are true and that all statements made on information and belief are believed to be true: and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Signature: Joseph L. Pikulski
Inventor's Name: Joseph L. Pikulski
Residence: 32009 Foxmoor Court
Westlake Village, CA 91361

Date: Jan 19, 2004

Country of Citizenship: USA
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